CY7C1019B/ CY7C10191B



Features

- High speed—t_{AA} = 10, 12, 15 ns
- CMOS for optimum speed/power
- Center power/ground pinout
- Automatic power-down when deselected
- Easy memory expansion with CE and OE options
- Functionally equivalent to CY7C1019

Functional Description

The CY7C1019B/10191B is a high-performance CMOS static RAM organized as 131,072 words by 8 bits. Easy memory expansion is provided by an active LOW Chip Enable (CE), an active LOW Output Enable (OE), and three-state drivers. This device has an automatic power-down feature that significantly reduces power consumption when deselected.

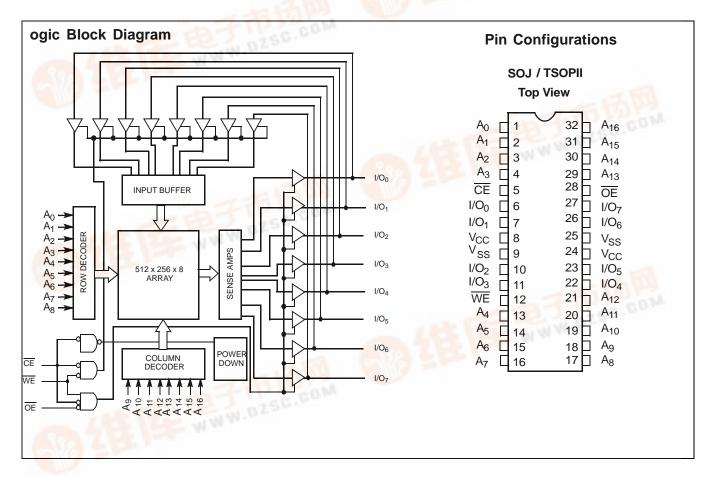
128K x 8 Static RAM

<u>Writing</u> to the device is <u>accomplished</u> by taking Chip Enable (\overline{CE}) and Write Enable (\overline{WE}) inputs LOW. Data on the eight I/O pins (I/O₀ through I/O₇) is then written into the location specified on the address pins (A₀ through A₁₆).

Reading from the device is accomplished by taking Chip Enable (CE) and Output Enable (OE) LOW while forcing Write Enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The eight input/output pins (I/O $_0$ through I/O $_7$) are placed in a high-impedance state when the device is deselected ($\overline{\text{CE}}$ HIGH), the outputs are disabled ($\overline{\text{OE}}$ HIGH), or during a write operation ($\overline{\text{CE}}$ LOW, and $\overline{\text{WE}}$ LOW).

The CY7C1019B/10191B is available in standard 32-pin TSOP Type II and 400-mil-wide SOJ packages. Customers should use part number CY7C10191B when ordering parts with 10 ns t_{AA} , and CY7C1019B when ordering 12 and 15 ns t_{AA} .







Selection Guide

		7C10191B-10	7C1019B-12	7C1019B-15
Maximum Access Time (ns)		10	12	15
Maximum Operating Current (mA)		150	140	130
Maximum Standby Current (mA)		10	10	10
	L	-	1	1

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature-65°C to +150°C

Ambient Temperature with

Power Applied......55°C to +125°C

Supply Voltage on V_{CC} to Relative $GND^{[1]}$ -0.5V to +7.0V

DC Voltage Applied to Outputs in High Z State $^{[1]}$ -0.5V to V CC + 0.5V

DC Input Voltage^[1].....-0.5V to V_{CC} + 0.5V

Current into Outputs (LOW) 20 mA Static Discharge Voltage.....>2001V (per MIL-STD-883, Method 3015) Latch-Up Current.....>200 mA

Operating Range

Range	Ambient Temperature ^[2]	V _{CC}
Commercial	0°C to +70°C	5V ± 10%
Industrial	-40°C to +85°C	5V ± 10%

Electrical Characteristics Over the Operating Range

				7C10191B-10		7C101	9B-12	7C101	9B-15	
Parameter	Description	Test Conditions	Test Conditions		Max.	Min.	Max.	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	$V_{CC} = Min.,$ $I_{OH} = -4.0 \text{ mA}$				2.4		2.4		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 8.0 mA			0.4		0.4		0.4	V
V _{IH}	Input HIGH Voltage				V _{CC} + 0.3	2.2	V _{CC} + 0.3	2.2	V _{CC} + 0.3	V
V_{IL}	Input LOW Voltage[1]			-0.3	0.8	-0.3	0.8	-0.3	0.8	V
I _{IX}	Input Load Current	$GND \le V_I \le V_{CC}$		-1	+1	-1	+1	-1	+1	μΑ
I _{OZ}	Output Leakage Current	$\begin{array}{l} \text{GND} \leq \text{V}_{\text{I}} \leq \text{V}_{\text{CC}}, \\ \text{Output Disabled} \end{array}$		- 5	+5	- 5	+5	-5	+5	μΑ
Icc	V _{CC} Operating Supply Current	$V_{CC} = Max.,$ $I_{OUT} = 0 \text{ mA},$ $f = f_{MAX} = 1/t_{RC}$			150		140		130	mA
I _{SB1}	Automatic CE	Max. V_{CC} , $\overline{CE} \ge V_{IH}$			40		40		40	mA
	Power-Down Current —TTL Inputs	$V_{IN} \ge V_{IH}$ or $V_{IN} \le V_{IL}$, $f = f_{MAX}$	L		20		20		20	
I _{SB2}	Automatic CE	Max. V _{CC} ,			10		10		10	mA
	Power-Down Current —CMOS Inputs	$\label{eq:center_constraints} \begin{split} \text{CE} &\geq \text{V}_{CC} - 0.3\text{V},\\ \text{V}_{\text{IN}} &\geq \text{V}_{CC} - 0.3\text{V},\\ \text{or } \text{V}_{\text{IN}} &\leq 0.3\text{V}, \text{f} = 0 \end{split}$	L		_		1		1	

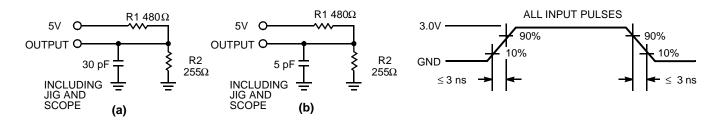
Capacitance^[3]

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_A = 25^{\circ}C$, $f = 1$ MHz,	6	pF
C _{OUT}	Output Capacitance	$V_{CC} = 5.0V$	8	pF

- 1. V_{IL} (min.) = -2.0V for pulse durations of less than 20 ns.
- 2. T_{Δ} is the "Instant On" case temperature.
- 3. Tested initially and after any design or process changes that may affect these parameters.



AC Test Loads and Waveforms



THÉVENIN EQUIVALENT Equivalent to: **—**O 1.73V

Switching Characteristics^[4] Over the Operating Range

		7C101	91B-10	7C1019B-12		7C1019B-15		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
Read Cycle		•	•	•	•	•	-	
t _{RC}	Read Cycle Time	10		12		15		ns
t _{AA}	Address to Data Valid		10		12		15	ns
t _{OHA}	Data Hold from Address Change	3		3		3		ns
t _{ACE}	CE LOW to Data Valid		10		12		15	ns
t _{DOE}	OE LOW to Data Valid		5		6		7	ns
t _{LZOE}	OE LOW to Low Z	0		0		0		ns
t _{HZOE}	OE HIGH to High Z ^[5, 6]		5		6		7	ns
t _{LZCE}	CE LOW to Low Z ^[6]	3		3		3		ns
t _{HZCE}	CE HIGH to High Z ^[5, 6]		5		6		7	ns
t _{PU}	CE LOW to Power-Up	0		0		0		ns
t _{PD}	CE HIGH to Power-Down		10		12		15	ns
Write Cycle ^{[7}	·, 8]							•
t _{WC}	Write Cycle Time	10		12		15		ns
t _{SCE}	CE LOW to Write End	8		9		10		ns
t _{AW}	Address Set-Up to Write End	7		8		10		ns
t _{HA}	Address Hold from Write End	0		0		0		ns
t _{SA}	Address Set-Up to Write Start	0		0		0		ns
t _{PWE}	WE Pulse Width	7		8		10		ns
t _{SD}	Data Set-Up to Write End	5		6		8		ns
t _{HD}	Data Hold from Write End	0		0		0		ns
t _{LZWE}	WE HIGH to Low Z ^[6]	3		3		3		ns
t _{HZWE}	WE LOW to High Z ^[5, 6]		5		6		7	ns

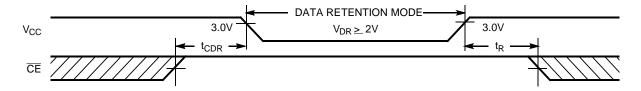
- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I_{OL}/I_{OH} and 30-pF load capacitance.
- t_{HZOE} , t_{HZCE} , and t_{HZWE} are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured ± 500 mV from steady-state voltage. 5.
- 6.
- thzop: thzop: thzop: The specified with a road capacitatice of 5 pr as in part (ii) of AC test Loads. Transition is Theasured 2500 in Minimal a road capacitatice of 5 pr as in part (ii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (ii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iii) of AC test Loads. Transition is Theasured 2500 in Minimal acade capacitatice of 5 pr as in part (iiii) of AC test Loads. Transi



Data Retention Characteristics Over the Operating Range (L Version Only)

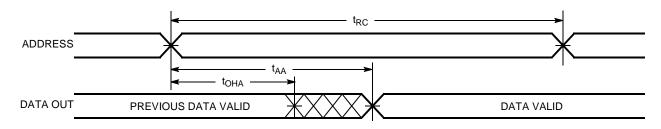
Parameter	Description	Conditions	Min.	Max.	Unit
V_{DR}	V _{CC} for Data Retention	No input may exceed V _{CC} + 0.5V	2.0		V
I _{CCDR}	Data Retention Current	$\frac{V_{CC}}{CE} = V_{DR} = 2.0V,$ $CE \ge V_{CC} - 0.3V,$		300	μΑ
t _{CDR} ^[3]	Chip Deselect to Data Retention Time	$V_{IN} \ge V_{CC} - 0.3V$ or $V_{IN} \le 0.3V$	0		ns
t _R	Operation Recovery Time		200		μs

Data Retention Waveform

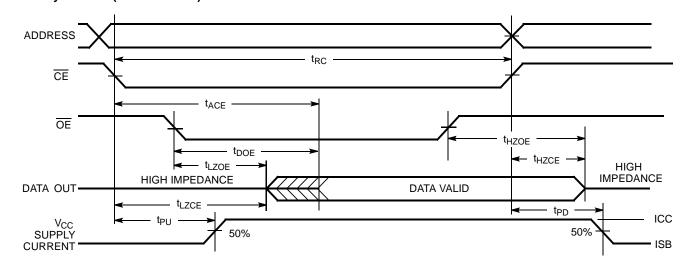


Switching Waveforms

Read Cycle No. 1^[9, 10]



Read Cycle No. 2 (OE Controlled)[10, 11]

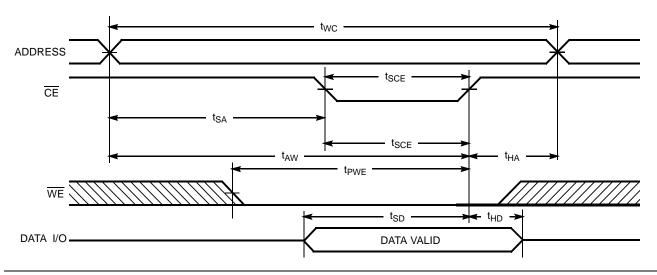


- 9. Device is continuously selected. \overline{OE} , $\overline{CE} = V_{IL}$.
- 10. WE is HIGH for read cycle.
 11. Address valid prior to or coincident with CE transition LOW.

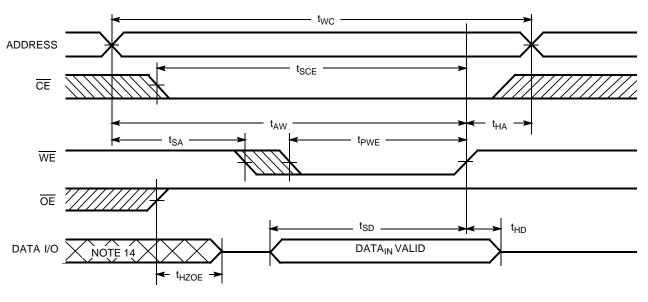


Switching Waveforms (continued)

Write Cycle No. 1 (CE Controlled)[12, 13]



Write Cycle No. 2 (WE Controlled, OE HIGH During Write)[12, 13]

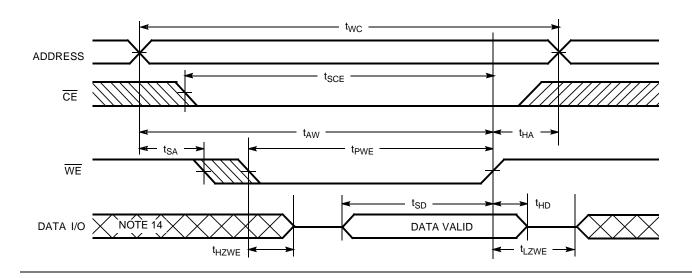


- Data I/O is high impedance if OE = V_{IH}.
 If CE goes HIGH simultaneously with WE going HIGH, the output remains in a high-impedance state.
 During this period the I/Os are in the output state and input signals should not be applied.



Switching Waveforms (continued)

Write Cycle No. 3 ($\overline{\text{WE}}$ Controlled, $\overline{\text{OE}}$ LOW) $^{[13]}$



Truth Table

CE	OE	WE	I/O ₀ -I/O ₇	Mode	Power
Н	Х	Х	High Z	Power-Down	Standby (I _{SB})
Х	Х	Х	High Z	Power-Down	Standby (I _{SB})
L	L	Н	Data Out	Read	Active (I _{CC})
L	Х	L	Data In	Write	Active (I _{CC})
L	Н	Н	High Z	Selected, Outputs Disabled	Active (I _{CC})

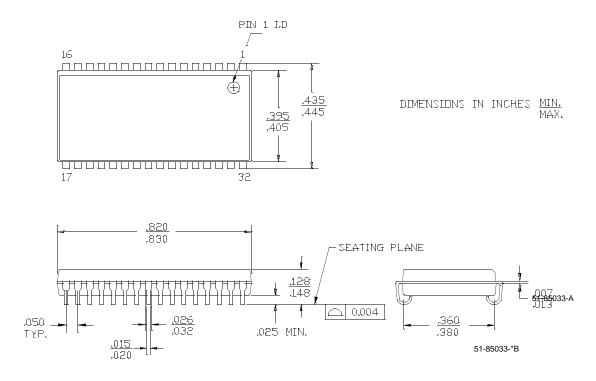
Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C10191B-10VC	V33	32-Lead 400-Mil Molded SOJ	Commercial
12	CY7C1019B-12VC	V33	32-Lead 400-Mil Molded SOJ	Commercial
	CY7C1019B-12ZC	ZS32	32-Lead TSOP Type II	Commercial
15	CY7C1019B-15VC	V33	32-Lead 400-Mil Molded SOJ	Commercial
	CY7C1019B-15VI	V33	32-Lead 400-Mil Molded SOJ	Industrial
	CY7C1019B-15ZC	ZS32	32-Lead TSOP Type II	Commercial
	CY7C1019B-15ZI	ZS32	32-Lead TSOP Type II	Industrial



Package Diagrams

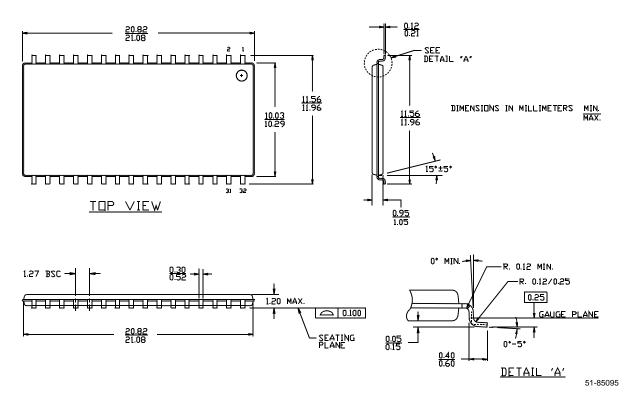
32-Lead (400-Mil) Molded SOJ V33





Package Diagrams (continued)

32-Lead TSOP II ZS32



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	Document Title: CY7C1019B/CY7C10191B 128K x 8 Static RAM Document Number: 38-05026								
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change					
**	109949	09/25/01	SZV	Change from Spec number: 38-01115 to 38-05026					
*A	116170	08/14/02	HGK	SOJ (400-mil) package outline replacing incorrect SOJ package Pin for pin compatible with CY7C1019 Industrial packages added to Ordering Information					